IPC ASSOCIATION ELECTRONICS	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and I	Mfg Inform	mation				
Supplier	Information															
Company name* Company				ny unique ID			Unique ID Authority					Response Date*				
nsemi													2023-06-08			
Contact Na	me	Title - Contact			I	Phone - Contact*					Email - Contact*					
Product-Er	nv-Stewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized	Representative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*					
Product-E1	nv-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com					
	Requester Item Number		Mfr Item Number Mfr Item Name				Effective Da	ite Vei	rsion	Manufacturing Site		Weight*	UOM		Unit Type	
		AMIS30622C6227G I2C 800MA		I2C 800MA STEPF	800MA STEPPER DRIVER		2023-06-08		PHG		612.57	mg		Each		
Manufact	turing Proccess Informa	ition						,				<u> </u>	İ		•	
7	Terminal Plating / Grid Array Material Ter			erminal Base Alloy J-STD-020 MSL		SL Rating	Peak Process Body Temper		dy Temperati	ature Max Time at Peak Tempe		ature Nu	umber of Reflo	w Cycles		
Matte Tin (Sn) - annealed CU Alloy			2		260		C	C 30		seconds 3						
Comments																
TTENTIC	ON: MSL 2 Rated item require	es Dry Pack (a	fter electrical	test)												
or more in	formation regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	35.93	mg	Supplier	Silicon (Si)	7440-21-3		35.93		
Die Attach	6.55	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		1.5065	mg	
			Supplier	Silver (Ag)	7440-22-4		5.0435	mg	
Lead Frame	188.57	mg	Supplier	Zinc (Zn)	7440-66-6		0.1886	mg	
			Supplier	Iron (Fe)	7439-89-6		4.3371	mg	
			Supplier	Copper (Cu)	7440-50-8		183.8558	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.1886	mg	
Mold Compound-Black	377.0	mg		Epoxy Phenol Resin	proprietary data		39.585	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		337.415	mg	
Plating	3.7	mg	Supplier	Tin (Sn)	7440-31-5		3.7	mg	
Wire Bond - Au	0.82	mg	Supplier	Gold (Au)	7440-57-5		0.82	mg	